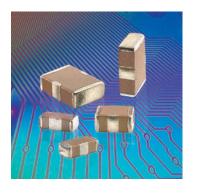
## X2Y<sup>®</sup> FILTER & DECOUPLING CAPACITORS



X2Y<sup>®</sup> filter capacitors employ a unique, patented low inductance design featuring two balanced capacitors that are immune to temperature, voltage and aging performance differences.

These components offer superior decoupling and EMI filtering performance, virtually eliminate parasitics, and can replace multiple capacitors and inductors saving board space and reducing assembly costs.

#### **A**DVANTAGES

- One device for EMI suppression or decoupling
- Replace up to 7 components with one X2Y
- Differential and common mode attenuation
- Matched capacitance line to ground, both lines
- Low inductance due to cancellation effect

#### **APPLICATIONS**

- Amplifier FIlter & Decoupling
- High Speed Data Filtering
- EMC I/O Filtering
- $\bullet$  FPGA / ASIC /  $\mu\text{-P}$  Decoupling

P/N written: 101X14W102MV4T

DDR Memory Decoupling

EMI Filtering (1 Y-Cap.)		<10pF	10pF	22pF	27pF	33pF	47pF	100pF	220pF	470pF	1000pF	1500pF	2200pF	4700pF	.010µF	.015µF	.022µF	.039µF	.047µF	0.10µF	0.18µF	0.22µF	0.33µF	0.40µF	0.47µF	1.0µF
Power Bypass (2 Y-Caps.)		<20pF	20pF	44pF	54pF	66pF	94pF	200pF	440pF	940pF	2000pF	3000pF	4400pF	9400pF	.020µF	.030µF	.044µF	.078µF	.094µF	0.20µF	0.36µF	0.44µF	0.68µF	0.80µF	0.94µF	2.0µF
SIZE	CAP. CODE	XRX	100	220	270	330	470	101	221	471	102	152	222	472	103	153	223	393	473	104	184	224	334	404	474	105
0400 (207)	NPO	50	50	50	50	50	50	50																		
0402 (X07)	X7R								50	50	50	50	50	50	16											
	NPO	100	100	100	100	100	50	50	50																	
0603 (X14)	X7R						100	100	100	100	100	100	100	100	50	25	25		16	10		10				
	X5R																					16	10		10	10
0005 (V15)	NPO		100	100	100	100	100	100	100	50																
0805 (X15)	X7R							100	100	100	100	100	100	100	100	50	50		50	25	10					
1000 (V10	NPO			VOLTAGE RATINGS						100																
1206 (X18	X7R			6.3 :	= 6.3	VDC									100	100	100		100	100		16	16		10	
1210 (X41)	X7R			16 :	= 10 \ = 16 \	/DC									500					100		100	100		25	16
1410 (X44)	X7R			50 :	= 25 \ = 50 \	/DC										500								100		
1812 (X43)	X7R				= 100 = <mark>500</mark>	-												500							100	

Contact factory for part combinations not shown.

Filtering capacitance is specified as Line-to-Ground (Terminal A or B to G)

Power Bypass capacitance is specified Power-to-Ground (A + B to G)

Rated voltage is from line to ground in Circuit 1, power to ground in Circuit 2 .

### How to Order X2Y® CAPACITORS

#### V Т 100 **X14** W 102 Μ 4 VOLTAGE SIZE DIELECTRIC CAPACITANCE TOLERANCE TERMINATION MARKING PACKING =Embossed 7" =Punched 7" X07=0402 $M = \pm 20\%$ 6R3 = 6.3 V N = NPO 1st two digits are signifi-V = NI Barrier with 100% 4 = Unmarked Е $* D = \pm 0.50 \text{ pF}$ 100 = 10 V160 = 16 VX14=0603 W = X7Rcant; third digit denotes Tin Plating (Matte) (Not available) X15=0805 number of zeros, R = X = X5R\*Values < 10 pF only F = Polyterm No code = bulk 250 = 25 V X18=1206 decimal. $\begin{array}{r} 500 = 50 \text{ V} \\ 101 = 100 \text{ V} \\ 501 = 500 \text{ V} \end{array}$ flexible termination 102 = 1000 pF 104 = 0.10 µF X41=1210 X44=1410 Tape specs. per EIA RS481 T = SnPb X43=1812 5R6 = 5.6pF

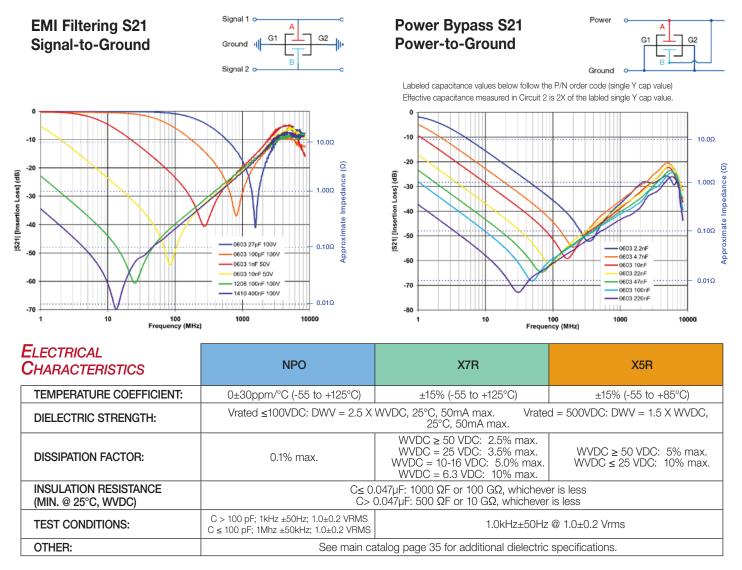
X2Y<sup>®</sup> technology patents and registered trademark under license from X2Y ATTENUATORS, LLC



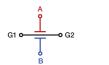
#### www.johansondielectrics.com

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# X2Y<sup>®</sup> FILTER & DECOUPLING CAPACITORS



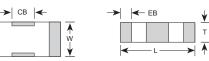
Equivalent Circuits



### Cross-sectional View



#### **Dimensional View**



#### CASE SIZE

	0402 (X07)		0603 (X14)		0805 (X15)		1206 (X18)		1210	(X41)	1410	(X44)	1812 (X43)		
	IN	MM													
L	0.045 ± 0.003	1.143 ± 0.076	0.064 ± 0.005	1.626 ± 0.127	0.080 ± 0.008	2.032 ± 0.203	0.124 ± 0.010	3.150 ± 0.254	0.125 ± 0.010	3.175 ± 0.254	0.140 ± 0.010	3.556 ± 0.254	0.174 ± 0.010	4.420 ± 0.254	
W	0.025 ± 0.003	0.635 ± 0.076	0.035 ± 0.005	0.889 ± 0.127	0.050 ± 0.008	1.270 ± 0.203	0.063 ± 0.010	1.600 ± 0.254	0.098 ± 0.010	2.489 ± 0.254	0.098 ± 0.010	2.490 ± 0.254	0.125 ± 0.010	3.175 ± 0.254	
т	0.020 max	0.508 max	0.026 max	0.660 max	0.040 max	1.016 max	0.050 max	1.270 max	0.070 max	1.778 max	0.070 max	1.778 max	0.090 max	2.286 max	
EB	0.008 ± 0.003	0.203 ± 0.076	0.010 ± 0.006	0.254 ± 0.152	0.012 ± 0.008	0.305 ± 0.203	0.016 ± 0.010	0.406 ± 0.254	0.018 ± 0.010	0.457 ± 0.254	0.018 ± 0.010	0.457 ± 0.254	0.022 ± 0.012	0.559 ± 0.305	
СВ	0.012 ± 0.003	0.305 ± 0.076	0.018 ± 0.004	0.457 ± 0.102	0.022 ± 0.005	0.559 ± 0.127	0.040 ± 0.005	1.016 ± 0.127	0.045 ± 0.005	1.143 ± 0.127	0.045 ± 0.005	1.143 ± 0.127	0.045 ± 0.005	1.143 ± 0.127	

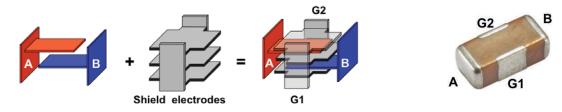


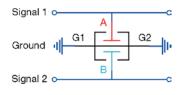


#### THE X2Y® DESIGN - A BALANCED, LOW ESL, "CAPACITOR CIRCUIT"

The X2Y<sup>®</sup> capacitor design starts with standard 2 terminal MLC capacitor's opposing electrode sets, A & B, and adds a third electrode set (G) which surround each A & B electrode. The result is a highly vesatile three node capacitive circuit containing two tightly matched, low inductance capacitors in a compact, four-terminal SMT chip.

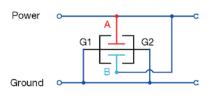






#### EMI FILTERING:

The X2Y<sup>®</sup> component contains two shunt or "line-to-ground" Y capacitors. Ultra-low ESL (equivalent series inductance) and tightly matched inductance of these capacitors provides unequaled high frequency Common-Mode noise filtering with low noise mode conversion. X2Y<sup>®</sup> components reduce EMI emissions far better than unbalanced discrete shunt capacitors or series inductive filters. Differential signal loss is determined by the cut off frequency of the single line-to-ground (Y) capacitor value of an X2Y<sup>®</sup>.



#### POWER BYPASS / DECOUPLING

For Power Bypass applications, X2Ys<sup>®</sup> two "Y" capacitors are connected in parallel. This doubles the total capacitance and reduces their mounted inductance by 80% or 1/5th the mounted inductance of similar sized MLC capacitors enabling high-performance bypass networks with far fewer components and vias. Low ESL delivers improved High Frequency performance into the GHz range.

#### **GSM RFI** ATTENUATION IN AUDIO & ANALOG

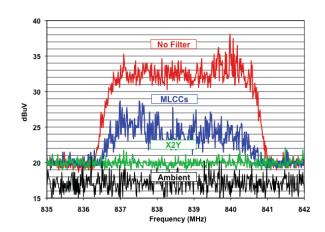
GSM handsets transmit in the 850 and 1850 MHz bands using a TDMA pulse rate of 217Hz. These signals cause the GSM buzz heard in a wide range of audio products from headphones to concert hall PA systems or "silent" signal errors created in medical, industrial process control, and security applications. Testing was conducted where an 840MHz GSM handset signal was delivered to the inputs of three different amplifier test circuit configurations shown below whose outputs were measured on a HF spectrum analyzer.

1) No input filter, 2 discrete MLC 100nF power bypass caps.

2) 2 discrete MLC 1nF input filter, 2 discrete MLC 100nF power bypass caps.

3) A single X2Y 1nF input filter, a single X2Y 100nF power bypass cap.

X2Y configuration provided a nearly flat response above the ambient and up to 10 dB imrpoved rejection than the conventional MLCC configuration.

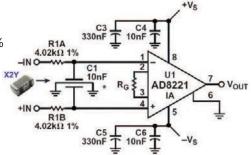


#### AMPLIFIER INPUT FILTER EXAMPLE

In this example, a single Johanson X2Y<sup>®</sup> component was used to filter noise at the input of a DC instrumentation amplifier. This reduced component count by 3-to-1 and costs by over 70% vs. conventional filter components that included 1% film Y-capacitors.

Parameter	X2Y <sup>®</sup> 10nF	Discrete 10nF, 2 @ 220 pF	Comments				
DC offset shift	< 0.1 µV	< 0.1 µV	Referred to input				
Common mode rejection	91 dB	92 dB					

Source: Analog Devices, "A Designer's Guide to Instrumentation Amplifiers (2nd Edition)" by Charles Kitchin and Lew Counts



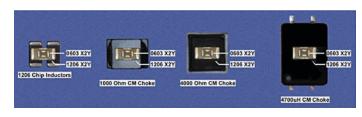




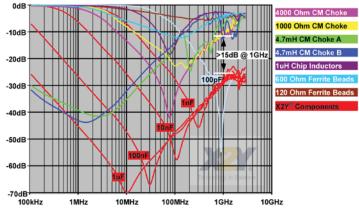
#### COMMON MODE CHOKE REPLACEMENT

- Superior High Frequency Emissions Reduction
- Smaller Sizes, Lighter Weight
- No Current Limitation
- Vibration Resistant
- No Saturation Concerns

See our website for a detailed application note with component test comparisons and circuit emissions measurements.

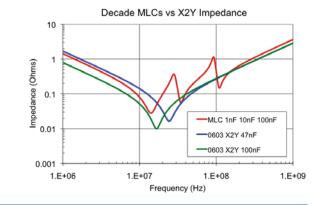


#### Measured Common Mode Rejection



#### PARALLEL CAPACITOR SOLUTION

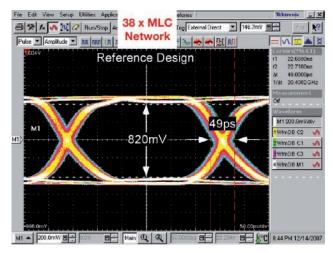
A common design practice is to parallel decade capacitance values to extend the high frequency performance of the filter network. This causes an unintended and often over-looked effect of anti-resonant peaks in the filter networks combined impedance. X2Y's very low mounted inductance allows designers to use a single, higher value part and completely avoid the anti-resonance problem. The impedance graph on right shows the combined mounted impedance of a 1nF, 10nF & 100nF 0402 MLC in parrallel in RED. The MLC networks anti-resonance peaks are nearly 10 times the desired impedance. A 100nF and 47nF X2Y are plotted in BLUE and GREEN. (The total capacitance of X2Y (Circuit 2) is twice the value, or 200nF and 98nF in this example.) The sigle X2Y is clearly superior to the three paralleled MLCs.



#### X2Y High Performance Power Bypass - Improve Performance, Reduce Space & Vias

Actual measured performance of two high performance SerDes FPGA designs demonstrate how a 13 component X2Y bypass network significantly out performs a 38 component MLC network. For more information see http://johansondielectrics.com/pdfs/JDI\_X2Y\_STXII.pdf

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